

Certificate TW19/10186

The management system of

# Greatek Electronics Inc.

No. 136 & No. 112, Gong-Yi Rd., Zhunan Township, Miaoli County, 350, Taiwan (R.O.C.)

has been assessed and certified as meeting the requirements of

## ANSI/ESD S20.20-2021

For the following activities

Site P1: Integrated Circuit Packaging and Testing.

Site P2: Provision of Wafer Bumping, Assembly Service, Integrated Circuit Packaging and Testing.

ESD Program Manager: Mr. TAI Liu

Further clarifications regarding the scope of this certificate and the applicability of ANSI/ESD S20.20-2021 requirements may be obtained by consulting the organization.

Lead Auditor: Nelson Kuo

Certification Manager: Roger S. Villanueva

This certificate is valid from 11 April 2026 until 10 April 2027

Issue 8. Certified since 11 April 2019

Certified activities performed by additional sites are listed on subsequent pages.



Authorised by

Roger Villanueva

SGS Philippines, Inc.

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Certificate TW19/10186, continued  
**Greatek Electronics Inc.**

**SGS**

**ANSI/ESD S20.20-2021**

Issue 8

**Sites**

Greatek Electronics Inc.  
No. 136 & No. 112, Gong-Yi Rd., Zhunan Township, Miaoli County, 350, Taiwan (R.O.C.)  
Integrated Circuit Packaging and Testing.

Greatek Electronics Inc.  
No. 9 & No. 11, Zhong-Min Rd., Toufen City, Miaoli County 351, Taiwan (R.O.C)  
Provision of Wafer Bumping, Assembly Service, Integrated Circuit Packaging and Testing.



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